

**Product Summary** (Typ. @  $V_{GS} = -4.5V$ ,  $T_A = +25^\circ C$ )

$V_{DSS}$	$R_{DS(on)}$	$Q_g$	$Q_{gd}$	$I_D$
-12V	85m $\Omega$	3.7nC	0.6nC	-2.6A

**Description**

This new generation MOSFET is designed to minimize the on-state resistance ( $R_{DS(on)}$ ) and yet maintain superior switching performance, making it ideal for high efficiency power management applications.

**Applications**

- Battery Management
- Load Switch
- Battery Protection

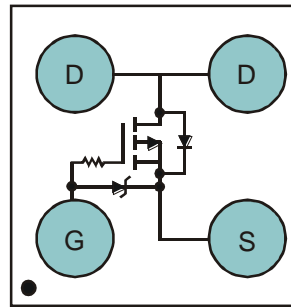
**Features**

- LD-MOS Technology with the Lowest Figure of Merit:  
 $R_{DS(on)} = 85m\Omega$  to Minimize On-State Losses  
 $Q_g = 3.7nC$  for Ultra-Fast Switching
- $V_{gs(th)} = -0.6V$  typ. for a Low Turn-On Potential
- CSP with Footprint 1.0mm x 1.0mm
- Height = 0.62mm for Low Profile
- ESD = 3kV HBM Protection of Gate
- **Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)**
- **Halogen and Antimony Free. "Green" Device (Note 3)**
- **Qualified to AEC-Q101 Standards for High Reliability**

**Mechanical Data**

- Case: U-WLB1010-4
- Terminal Connections: See Diagram Below
- Weight: 0.005 grams (Approximate)

U-WLB1010-4


 Top View  
Equivalent Circuit

**Ordering Information** (Note 3)

Part Number	Case	Packaging
DMP1096UCB4-7	U-WLB1010-4	3000/Tape & Reel

- Notes:
1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.
  2. See [http://www.diodes.com/quality/lead\\_free.html](http://www.diodes.com/quality/lead_free.html) for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
  3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
  4. For packaging details, go to our website at <http://www.diodes.com/products/packages.html>.

**Marking Information**


1W = Product Type Marking Code  
 YM = Date Code Marking  
 Y = Year (ex: X = 2010)  
 M = Month (ex: 9 = September)



BW = Product Type Marking Code  
 YM = Date Code Marking  
 Y = Year (ex: X = 2010)  
 M = Month (ex: 9 = September)

## Date Code Key

Year	2010	2011	2012	2013	2014	2015	2016	2017	2018
Code	X	Y	Z	A	B	C	D	E	F

Month	Jan	Feb	Mar	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code	1	2	3	4	5	6	7	8	9	O	N	D

**Maximum Ratings** (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic			Symbol	Value	Unit
Drain-Source Voltage			V <sub>DSS</sub>	-12	V
Gate-Source Voltage			V <sub>GSS</sub>	-5	V
Continuous Drain Current (Note 5) V <sub>GS</sub> = -4.5V	Steady State	T <sub>A</sub> = +25°C	I <sub>D</sub>	-2.6	A
		T <sub>A</sub> = +70°C		-2.1	
Continuous Drain Current (Note 5) V <sub>GS</sub> = -2.5V	Steady State	T <sub>A</sub> = +25°C	I <sub>D</sub>	-2.4	A
		T <sub>A</sub> = +70°C		-1.9	
Pulsed Drain Current (Note 6)			I <sub>DM</sub>	-10	A

**Thermal Characteristics**

Characteristic	Symbol	Value	Unit
Power Dissipation (Note 5)	P <sub>D</sub>	0.82	W
Thermal Resistance, Junction to Ambient @T <sub>A</sub> = +25°C (Note 5)	R <sub>θJA</sub>	150	°C/W
Operating and Storage Temperature Range	T <sub>J</sub> , T <sub>STG</sub>	-55 to +150	°C

**Electrical Characteristics** (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Typ	Max	Unit	Test Condition
<b>OFF CHARACTERISTICS (Note 7)</b>						
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	-12	-	-	V	V <sub>GS</sub> = 0V, I <sub>D</sub> = -250μA
Gate-Source Breakdown Voltage	BV <sub>GSS</sub>	-6.0	-	-	V	V <sub>DS</sub> = 0V, I <sub>G</sub> = -250μA
Zero Gate Voltage Drain Current T <sub>J</sub> = +25°C	I <sub>DSS</sub>	-	-	-1	μA	V <sub>DS</sub> = -9.6V, V <sub>GS</sub> = 0V
Gate-Source Leakage	I <sub>GSS</sub>	-	-	-500	nA	V <sub>GS</sub> = -5V, V <sub>DS</sub> = 0V
<b>ON CHARACTERISTICS (Note 7)</b>						
Gate Threshold Voltage	V <sub>GS(th)</sub>	-0.4	-0.6	-1.0	V	V <sub>DS</sub> = V <sub>GS</sub> , I <sub>D</sub> = -250μA
Static Drain-Source On-Resistance	R <sub>DS(on)</sub>	-	85	102	mΩ	V <sub>GS</sub> = -4.5V, I <sub>D</sub> = -500mA
		-	97	116		V <sub>GS</sub> = -2.5V, I <sub>D</sub> = -500mA
		-	127	152		V <sub>GS</sub> = -1.5V, I <sub>D</sub> = -500mA
Forward Transfer Admittance	Y <sub>fs</sub>	-	4	-	S	V <sub>DS</sub> = -6V, I <sub>D</sub> = -500mA
Diode Forward Voltage	V <sub>SD</sub>	-	-0.6	-1.0	V	V <sub>GS</sub> = 0V, I <sub>S</sub> = -500mA
<b>DYNAMIC CHARACTERISTICS (Note 8)</b>						
Input Capacitance	C <sub>iss</sub>	-	251	-	pF	V <sub>DS</sub> = -6V, V <sub>GS</sub> = 0V, f = 1.0MHz
Output Capacitance	C <sub>oss</sub>	-	359	-		
Reverse Transfer Capacitance	C <sub>rss</sub>	-	70	-		
Total Gate Charge	Q <sub>g</sub>	-	3.7	-	nC	V <sub>GS</sub> = -4.5V, V <sub>DS</sub> = -6V, I <sub>D</sub> = -500mA
Gate-Source Charge	Q <sub>gs</sub>	-	0.4	-		
Gate-Drain Charge	Q <sub>gd</sub>	-	0.6	-		
Gate Charge at V <sub>th</sub>	Q <sub>g(th)</sub>	-	0.2	-		
Turn-On Delay Time	t <sub>D(on)</sub>	-	17.6	-	ns	V <sub>DS</sub> = -6V, V <sub>GS</sub> = -2.5V, R <sub>G</sub> = 20Ω, I <sub>D</sub> = -500mA
Turn-On Rise Time	t <sub>r</sub>	-	26.9	-		
Turn-Off Delay Time	t <sub>D(off)</sub>	-	37.5	-		
Turn-Off Fall Time	t <sub>f</sub>	-	32.3	-		

- Notes:
- Device mounted on FR-4 PCB with minimum recommended pad layout, single sided.
  - Repetitive rating, pulse width limited by junction temperature.
  - Short duration pulse test used to minimize self-heating effect.
  - Guaranteed by design. Not subject to production testing.

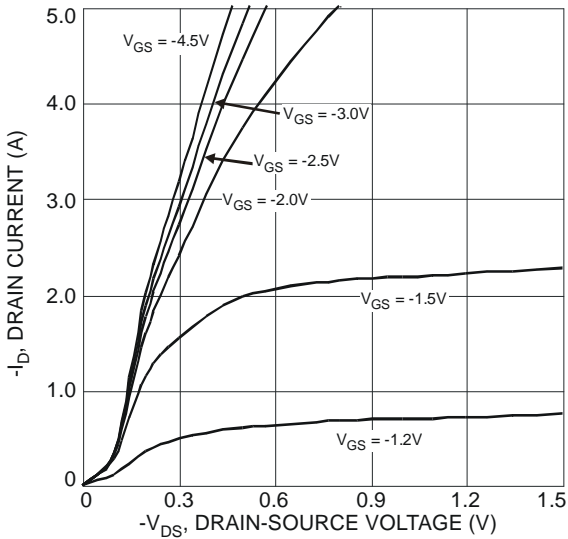


Fig. 1 Typical Output Characteristic

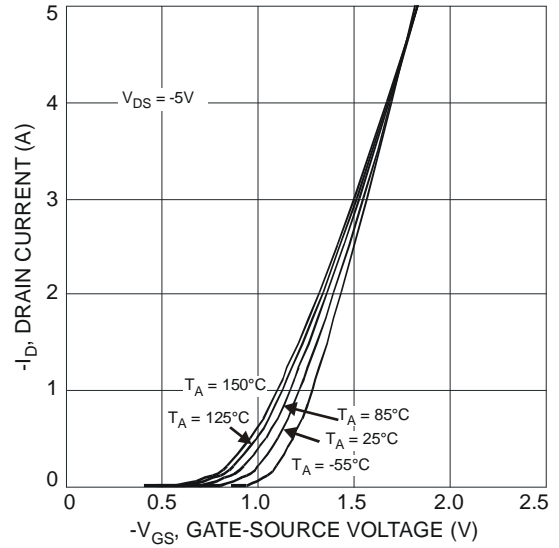


Fig. 2 Typical Transfer Characteristic

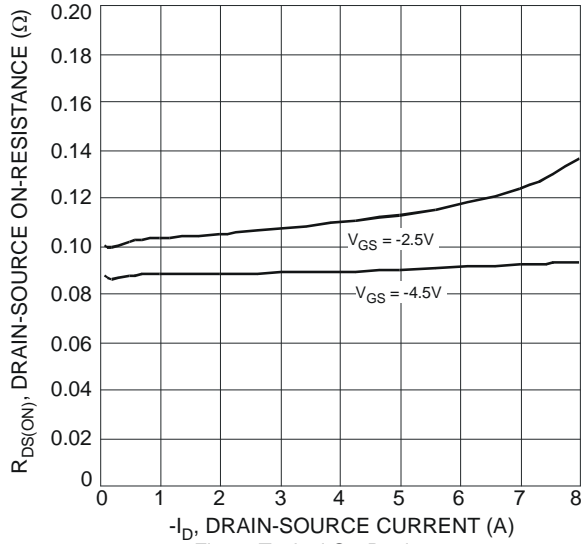


Fig. 3 Typical On-Resistance vs. Drain Current and Gate Voltage

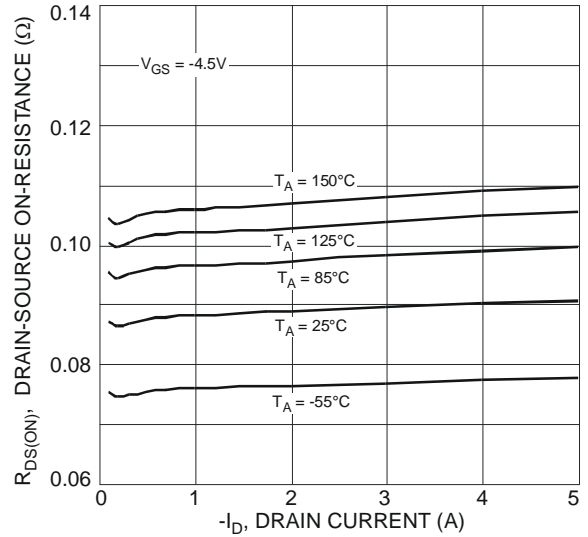


Fig. 4 Typical On-Resistance vs. Drain Current and Temperature

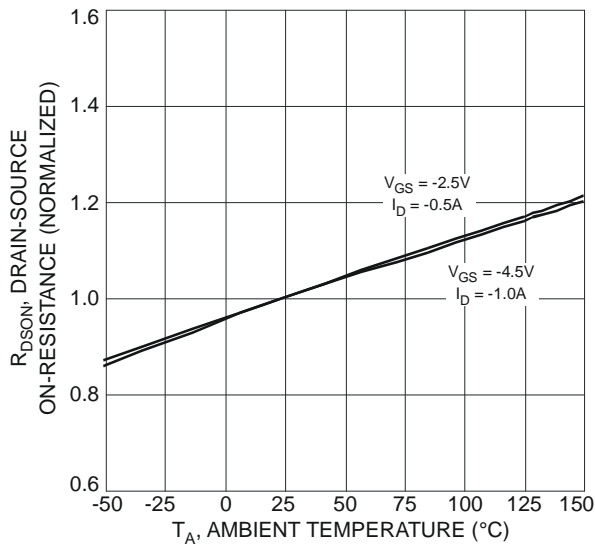


Fig. 5 On-Resistance Variation with Temperature

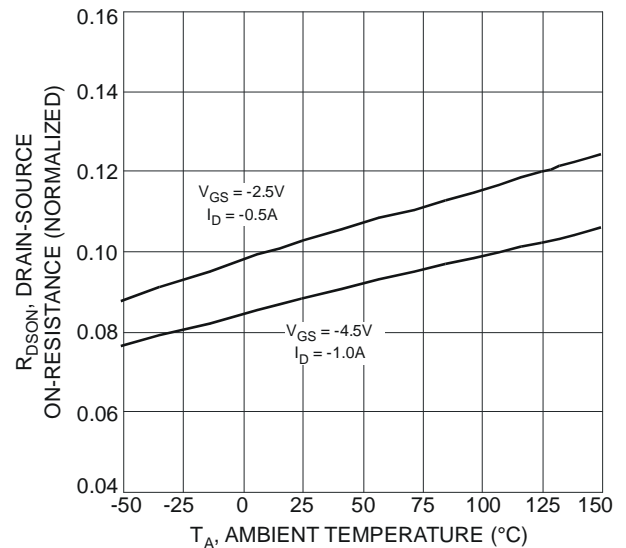


Fig. 6 On-Resistance Variation with Temperature

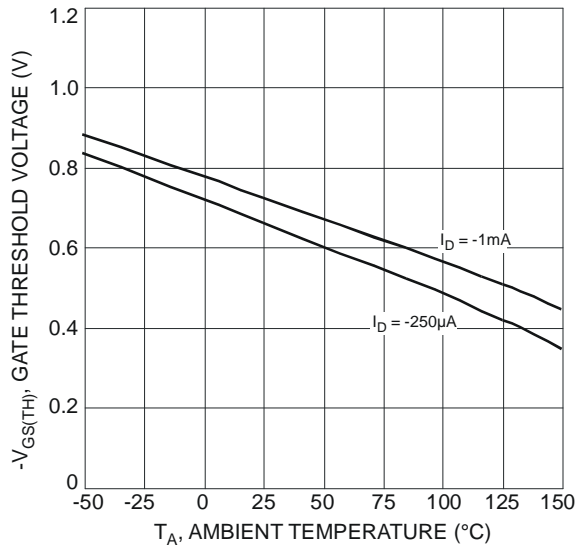


Fig. 7 Gate Threshold Variation vs. Ambient Temperature

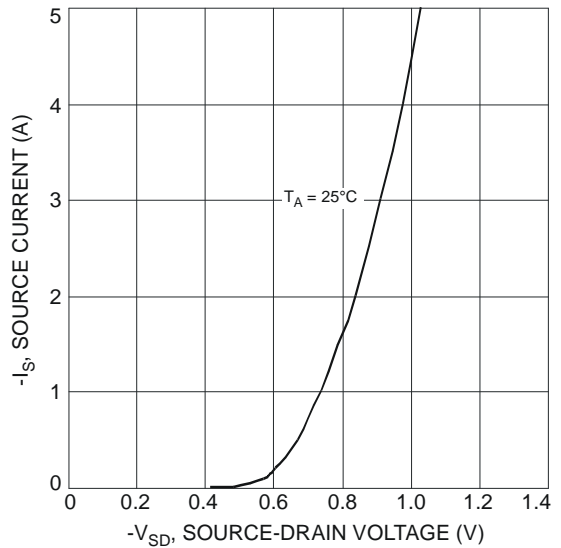


Fig. 8 Diode Forward Voltage vs. Current

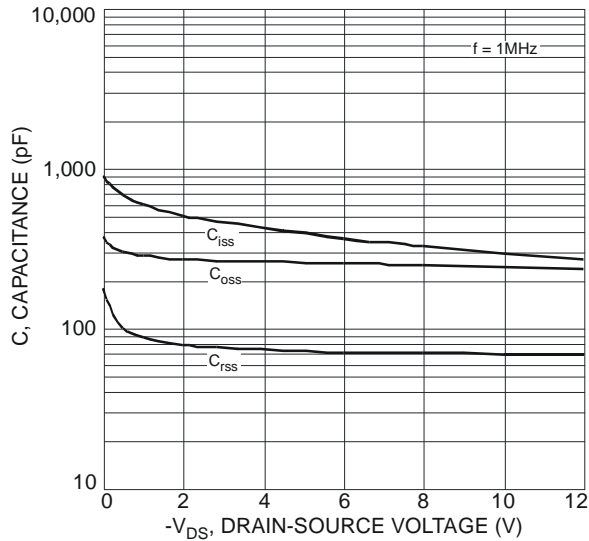


Fig. 9 Typical Total Capacitance

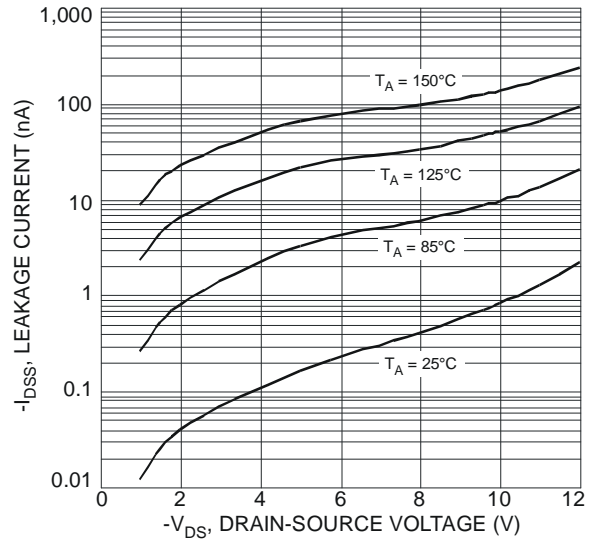


Fig. 10 Typical Leakage Current vs. Drain-Source Voltage

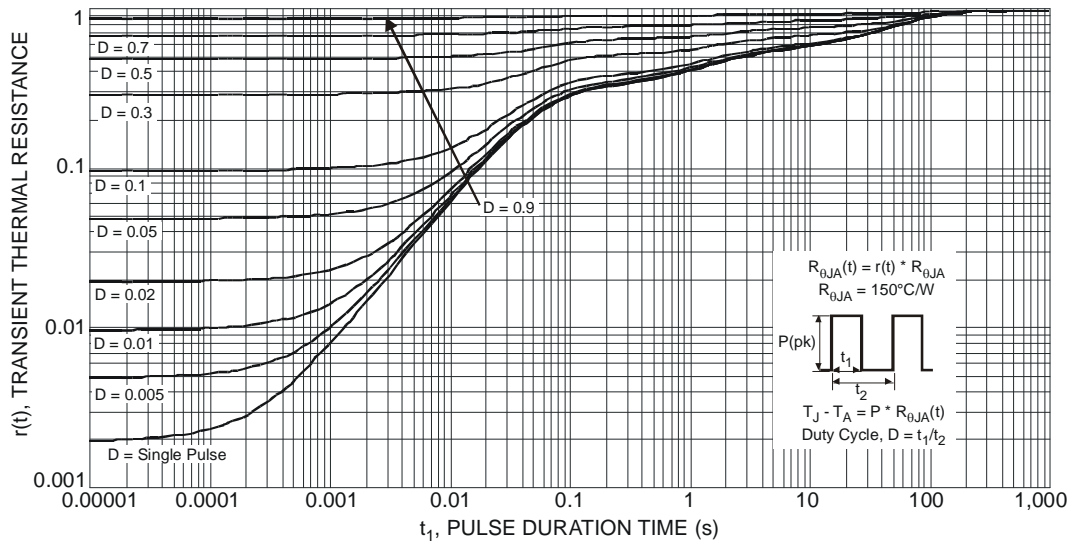
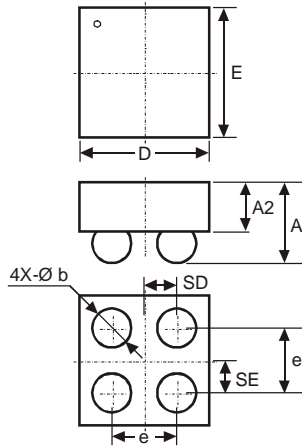


Fig. 11 Transient Thermal Response

**Package Outline Dimensions**

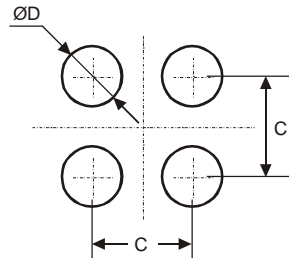
Please see AP02002 at <http://www.diodes.com/datasheets/ap02002.pdf> for the latest version.



U-WLB1010-4			
Dim	Min	Max	Typ
D	0.95	1.05	1.00
E	0.95	1.05	1.00
A	-	0.62	-
A2	-	-	0.38
b	0.25	0.35	0.30
e	-	-	0.50
SD	-	-	0.25
SE	-	-	0.25
All Dimensions in mm			

**Suggested Pad Layout**

Please see AP02001 at <http://www.diodes.com/datasheets/ap02001.pdf> for the latest version.



Dimensions	Value (in mm)
C	0.50
D	0.25

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